

Description

The AR0504MP is a low capacitance TVS array, utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive high-speed data lines. The AR0504MP has a low capacitance with a typical value at 0.6 pF, and complies with the IEC 61000-4-2 (ESD) with ±30kV air and ±30kV contact discharge. It is assembled into a 10-pin lead-free MSOP package. The flow through style package allows for easy PCB layout and matched trace lengths necessary to maintain consistent impedance between high speed differential lines. The small size, low capacitance and high ESD surge protection make AR0504MP an ideal choice to protect high speed ports.

Features

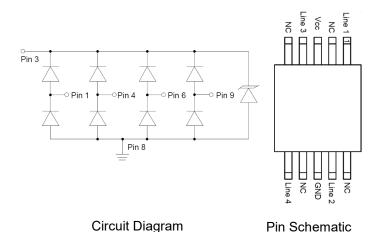
- Very low capacitance: 0.6pF typical
- Low operating voltage: 5V
- · Low clamping voltage
- Protects one power line and four data lines
- Flow-through package
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
 Air discharge: ±25kV

Contact discharge: ±20kV

- IEC61000-4-5 (Lightning) 5A (8/20µs)

RoHS Compliant

Dimensions and Pin Configuration



Mechanical Characteristics

Package: MSOP-10Lead Finish: Matte Tin

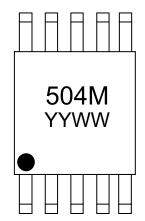
Case Material: "Green" Molding Compound.Terminal Connections: See Diagram Below

Marking Information: See Below

Applications

- DVI Ports
- HDMI Ports
- Set Top Box
- Projection TV
- Notebook Computers
- 10/100/1000 Ethernet
- Monitors and Flat Panel Displays

Marking Information



504M = Device Marking Code YYWW = Date Code Dot denotes pin1

Ordering Information

| Part Number | Packaging | Reel Size |
|-------------|------------------|-----------|
| AR0504MP | 3000/Tape & Reel | 13 inch |



Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

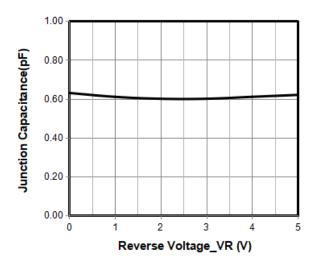
| Parameter | Symbol | Value | Unit |
|---------------------------------|--------|-------------|-------|
| Peak Pulse Power (8/20µs) | Ppk | 80 | W |
| Peak Pulse Current (8/20µs) | IPP | 5 | Α |
| ESD per IEC 61000-4-2 (Air) | Vsop | ±25 | 14) / |
| ESD per IEC 61000-4-2 (Contact) | VESD | ±20 | kV |
| Operating Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | Tstg | -55 to +150 | °C |

Electrical Characteristics (T_A=25°C unless otherwise specified)

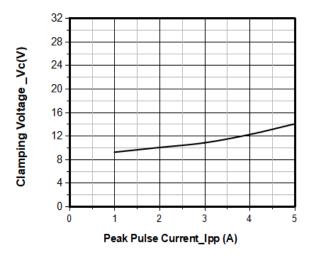
| Parameter | Symbol | Min | Тур | Max | Unit | Test Condition |
|-------------------------|----------------|-----|-----|------|------|--|
| Reverse Working Voltage | VRWM | | | 5 | V | |
| Breakdown Voltage | VBR | 6 | | | V | IT = 1mA |
| Reverse Leakage Current | I _R | | | 0. 5 | μA | VRWM = 5V |
| Clamping Voltage | Vc | | | 10 | V | IPP = 1A (8 x 20μs pulse) |
| Clamping Voltage | Vc | | | 16 | V | IPP = 5A (8 x 20μs pulse) |
| Junction Capacitance | CJ | | | 0.8 | pF | VR = 0V, f = 1MHz, any I/O pin to ground |



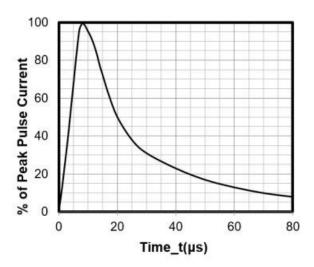
Typical Performance Characteristics (TA=25°C unless otherwise Specified)



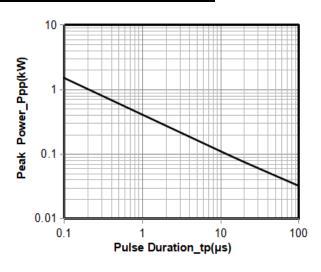
Junction Capacitance vs. Reverse Voltage



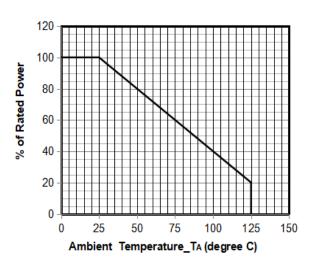
Clamping Voltage vs. Peak Pulse Current



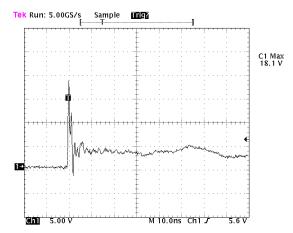
8 X 20µs Pulse Waveform



Peak Pulse Power vs. Pulse Time



Power Derating Curve



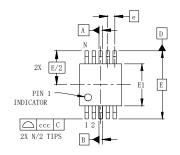
Note: Data is taken with a 10x attenuator

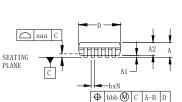
ESD Clamping Voltage

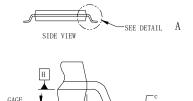
8 kV Contact per IEC61000-4-2



MSOP-10 Package Outline Drawing







DETAIL A

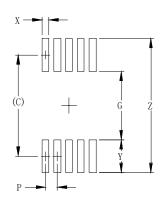
0.25

-H-

| DIM | TIVOTES | | | MILLLIMETERS | | | |
|-----|----------------|-----------|-------|--------------|----------|------|--|
| DIM | MIN | NOM MA | X MIN | | NMMX | | |
| A | - | - | . 043 | - | - | 1.10 | |
| A1 | .000 | - | .006 | 0.00 | - | 0.15 | |
| A2 | . 030 | - | . 037 | 0.75 | - | 0.95 | |
| b | . 007 | - | .011 | 0.17 | - | 0.27 | |
| С | . 003 | - | . 009 | 0.08 | - | 0.23 | |
| D | . 114 | . 118 | . 122 | 2.90 | 3.00 | 3.10 | |
| E1 | . 114 | . 118 | . 122 | 2.90 | 3.00 | 3.10 | |
| Е | . 193 BSC | | | 4. 90 BSC | | | |
| е | | . 020 BSC | | | 0.50 BSC | | |
| L | .016 .024 .032 | | | 0.40 | 0.60 | 0.80 | |
| L1 | (. 037) | | | (.95) | | | |
| N | 10 | | | 10 | | | |
| θ1 | 0° | - | 8° | 0° | - | 8° | |
| aaa | . 004 | | | | 0.10 | | |
| bbb | . 003 | | | 0.08 | | | |
| ccc | . 010 | | | 0.25 | | | |

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. DATUMS —A— AND —B— TO BE DETERMINED AT DATUM PLANE
- DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 4. REFERENCE JEDEC STD MO-187, VARIATION BA.

Suggested Land Pattern



| DIMENSIONS | | | | |
|------------|---------|-------------|--|--|
| DIM | INCHES | MILLIMETERS | | |
| С | (. 161) | (4.10) | | |
| G | . 098 | 2.50 | | |
| P | . 020 | 0.50 | | |
| X | .011 | 0.30 | | |
| Y | . 063 | 1.60 | | |
| Z | . 224 | 5. 70 | | |

NOTES:

 THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

Contact Information

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